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# FDY100PZ

## Single P-Channel (– 2.5V) Specified PowerTrench<sup>®</sup> MOSFET

#### **General Description**

Features

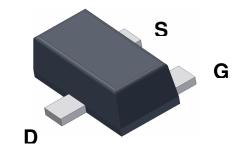
This Single P-Channel MOSFET has been designed using ON Semiconductor's advanced Power Trench process to optimize the  $R_{\text{DS(ON)}}$  @  $V_{\text{GS}}$  = - 2.5v.

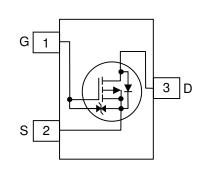
#### Applications

• Li-Ion Battery Pack



- ESD protection diode (note 3)
- RoHS Compliant





•  $-350 \text{ mA}, -20 \text{ V} \text{ R}_{\text{DS(ON)}} = 1.2 \ \Omega \ @ \text{V}_{\text{GS}} = -4.5 \text{ V}$ 

 $R_{\text{DS(ON)}} = 1.6 \ \Omega \ @ \ V_{\text{GS}} = - \ 2.5 \ V$ 

#### Absolute Maximum Ratings T<sub>A</sub>=25°C unless otherwise noted

| Symbol                            | Parameter                                    |           | Ratings     | Unit<br>s |
|-----------------------------------|--|-----------|-------------|-----------|
| V <sub>DSS</sub>                  | Drain-Source Voltage                         |           | - 20        | V         |
| V <sub>GSS</sub>                  | Gate-Source Voltage                          |           | ± 8         | V         |
| ID                                | Drain Current – Continuous                   | (Note 1a) | - 350       | mA        |
|                                   | – Pulsed                                     |           | - 1000      |           |
| PD                                | Power Dissipation (Steady State)             | (Note 1a) | 625         | mW        |
|                                   |  | (Note 1b) | 446         |           |
| T <sub>J</sub> , T <sub>STG</sub> | Operating and Storage Junction Temp<br>Range | perature  | -55 to +150 | °C        |

#### **Thermal Characteristics**

| R <sub>eJA</sub>      | Thermal Resistance, Junction-to-Ambient (Note 1a) | 200 | °C/W |
|-----------------------|---|-----|------|
| $R_{	extsf{	heta}JA}$ | Thermal Resistance, Junction-to-Ambient (Note 1b) | 280 |      |

### Package Marking and Ordering Information

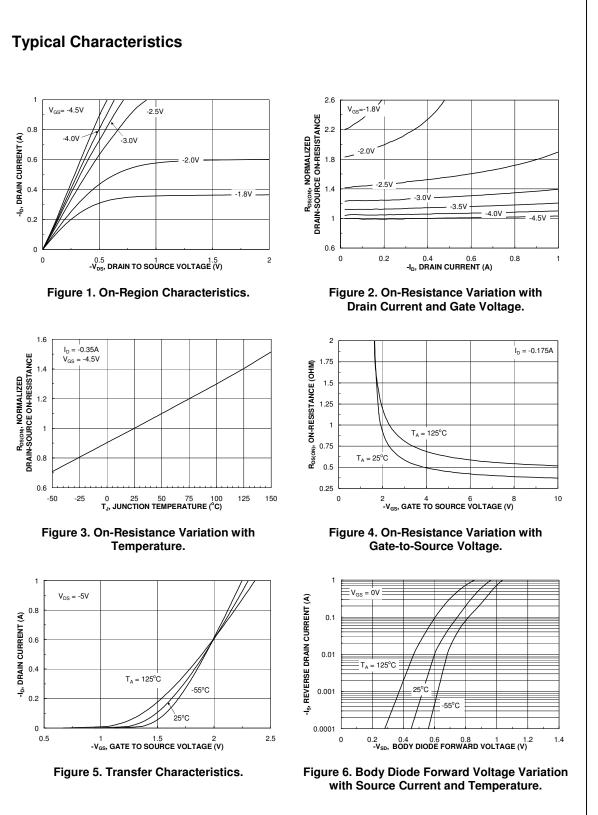
| Device Marking | Device   | Reel Size | Tape width | Quantity   |
|----------------|----------|-----------|------------|------------|
| <br>А          | FDY100PZ | 7"        | 8mm        | 3000 units |
|                |          |           |            |            |

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Publication Order Number: FDY100PZ/D

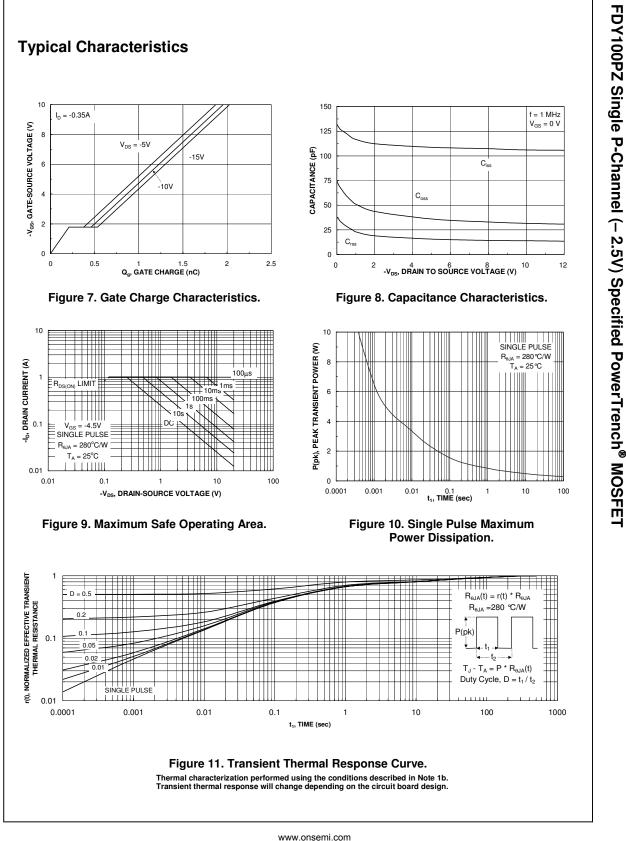
| <u></u>                                | Parameter   | Test Conditions  | Min    | Тур                      | Max                      | Units |
|--|---|--|--------|--------------------------|--------------------------|-------|
| Off Chara                              | acteristics                                       |  |        |                          |                          |       |
| BV <sub>DSS</sub>                      | Drain–Source Breakdown<br>Voltage                 | $V_{GS} = 0 V$ , $I_D = -250 \mu A$  | - 20   |                          |                          | V     |
| <u>ΔBV<sub>DSS</sub></u><br>ΔT,I       | Breakdown Voltage Temperature<br>Coefficient      | $I_D = -250 \ \mu\text{A}$ , Referenced to 25°C  |        | 15                       |                          | mV/°C |
| I <sub>DSS</sub>                       | Zero Gate Voltage Drain Current                   | $V_{DS} = -16 V$ , $V_{GS} = 0 V$  |        |                          | - 3                      | μA    |
| I <sub>GSS</sub>                       | Gate-Body Leakage,                                | $V_{\text{GS}} = \pm 8 \text{ V}, \qquad V_{\text{DS}} = 0 \text{ V}$  |        |                          | ± 10                     | μA    |
| On Chara                               | Acteristics (Note 2)                              |  |        |                          |                          |       |
| V <sub>GS(th)</sub>                    | Gate Threshold Voltage                            | $V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$   | - 0.65 | -1.0                     | - 1.5                    | V     |
| $\frac{\Delta V_{GS(th)}}{\Delta T_J}$ | Gate Threshold Voltage<br>Temperature Coefficient | $I_D = 250 \ \mu\text{A}$ , Referenced to 25°C   |        | -3                       |                          | mV/°C |
| R <sub>DS(on)</sub>                    | Static Drain–Source<br>On–Resistance              | $ \begin{array}{l} V_{GS}=-4.5 \ V, \ I_{D}=-350 \ mA \\ V_{GS}=-2.5 \ V, \ I_{D}=-300 \ mA \\ V_{GS}=-1.8 \ V, \ I_{D}=-150 \ mA \\ V_{GS}=-4.5 \ V, \ I_{D}=-350 \ mA, \\ T_{J}=125^{\circ}C \end{array} $ |        | 0.5<br>0.8<br>1.3<br>0.7 | 1.2<br>1.6<br>2.7<br>1.6 | Ω     |
| <b>g</b> <sub>FS</sub>                 | Forward Transconductance                          | $V_{DS} = -5 V$ , $I_D = -350 mA$  |        | 1                        |                          | S     |
| Dvnamic                                | Characteristics                                   |  |        |                          |                          |       |
| C <sub>iss</sub>                       | Input Capacitance                                 | $V_{DS} = -10 V$ , $V_{GS} = 0 V$ ,  |        | 100                      |                          | pF    |
|  | Output Capacitance                                | f = 1.0  MHz   |        | 30                       |                          | pF    |
| Crss                                   | Reverse Transfer Capacitance                      |  |        | 15                       |                          | pF    |
|  | · · ·   |  |        |                          | l                        | P.    |
|  | g Characteristics (Note 2)                        |  |        | C                        | 10                       | 20    |
| t <sub>d(on)</sub>                     | Turn-On Delay Time                                | $V_{DD} = -10 \text{ V},  I_D = -0.5 \text{ A}, V_{GS} = -4.5 \text{ V},  R_{GEN} = 6 \Omega$  |        | 6                        | 12                       | ns    |
| t <sub>r</sub>                         | Turn–On Rise Time                                 |  |        | 13                       | 23                       | ns    |
| t <sub>d(off)</sub>                    | Turn-Off Delay Time                               |  |        | 8                        | 16                       | ns    |
| t <sub>f</sub>                         | Turn–Off Fall Time                                |  |        | 1                        | 2                        | ns    |
| Q <sub>g</sub>                         | Total Gate Charge                                 | $V_{DS} = -10 \text{ V},  I_D = -350 \text{ mA},$<br>$V_{GS} = -4.5 \text{ V}$   |        | 1.0                      | 1.4                      | nC    |
| Q <sub>gs</sub>                        | Gate–Source Charge                                | $v_{GS} = -4.3 v$  |        | 0.2                      |                          | nC    |
| Q <sub>gd</sub>                        | Gate-Drain Charge                                 |  |        | 0.3                      |                          | nC    |
| Drain–So                               | urce Diode Characteristics                        | and Maximum Ratings  |        |                          |                          |       |
| V <sub>SD</sub>                        | Drain–Source Diode Forward<br>Voltage             | $V_{GS} = 0 V$ , $I_{S} = -150 m A$ (Note 2)   |        | -0.8                     | - 1.2                    | V     |
|  | Diode Reverse Recovery Time                       | $I_F = -350 \text{ mA},$   |        | 11                       |                          | ns    |
| t <sub>rr</sub>                        |   | $dI_F/dt = 100 \text{ A/}\mu\text{s}$  |        |                          |                          |       |

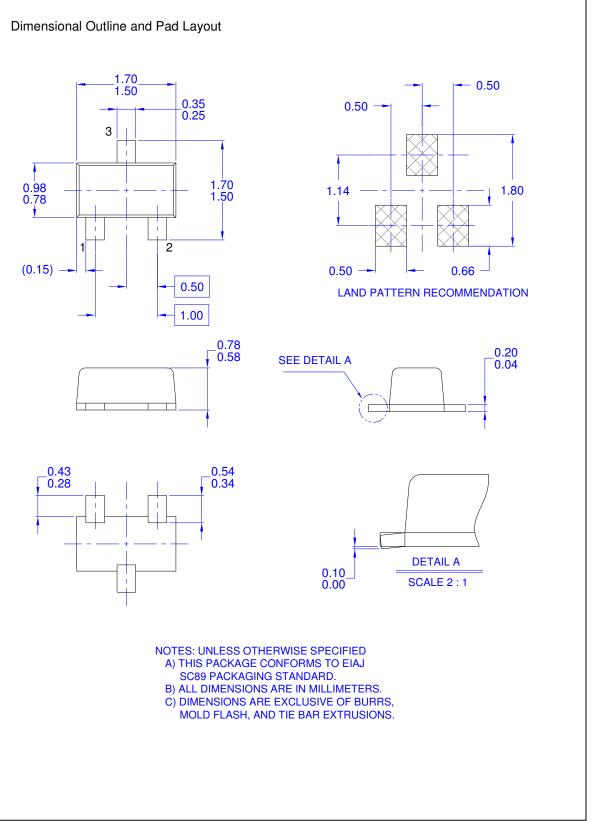
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